

HD74LS123

Dual Retriggerable Monostable Multivibrators (with Clear)

REJ03D0429-0200
Rev.2.00
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This d-c triggered multivibrator features output pulse width control by three method. The basic pulse time is programmed by selection of external resistance and capacitance values. Once triggered, the basic pulse width may be extended by retriggering the gated low-level -active (A) or high-level active (B) inputs, or be reduced by use of the overriding clear. Figure 1 illustrates pulse control by retriggering and early clear. This device is provided enough Schmitt hysteresis to ensure jitter-free triggering from the B input with transition rates as slow as 0.1 mV/ns.

Features

- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS123P	DILP-16 pin	PRDP0016AE-B (DP-16FV)	P	—
HD74LS123FPEL	SOP-16 pin (JEITA)	PRSP0016DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)
HD74LS123RPEL	SOP-16 pin (JEDEC)	PRSP0016DG-A (FP-16DNV)	RP	EL (2,500 pcs/reel)

Note: Please consult the sales office for the above package availability.

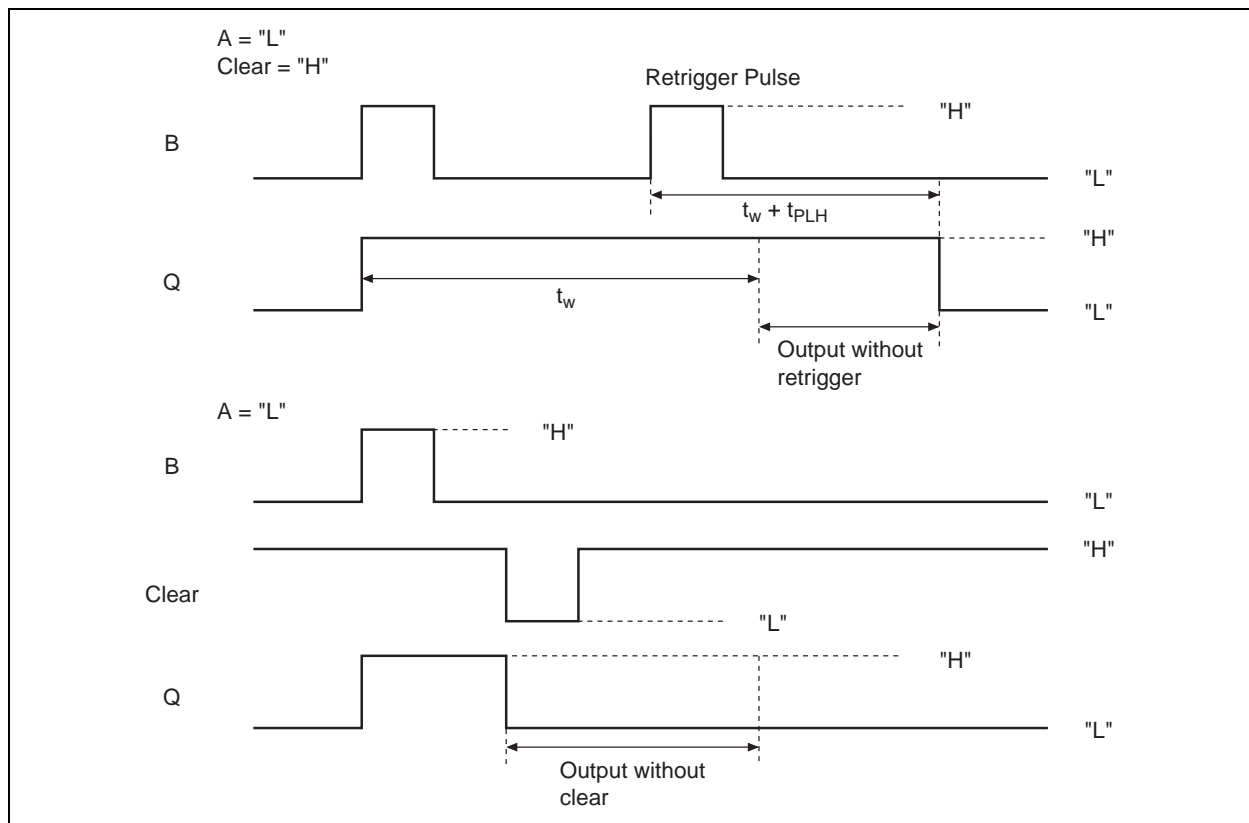
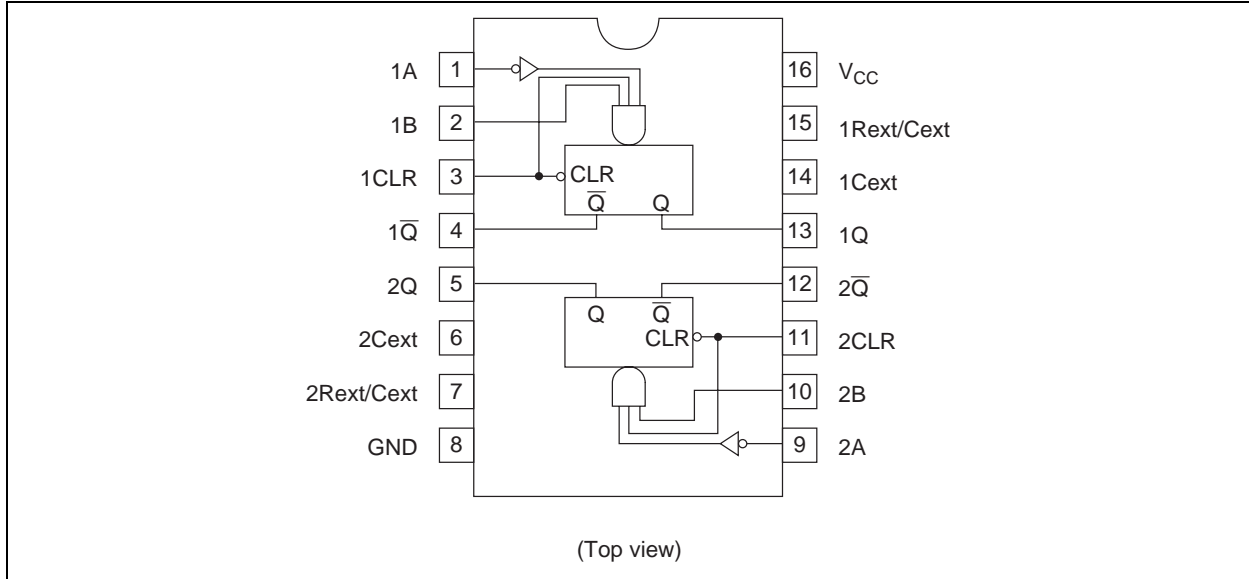


Figure 1 Typical Input / Output Pulse

Pin Arrangement

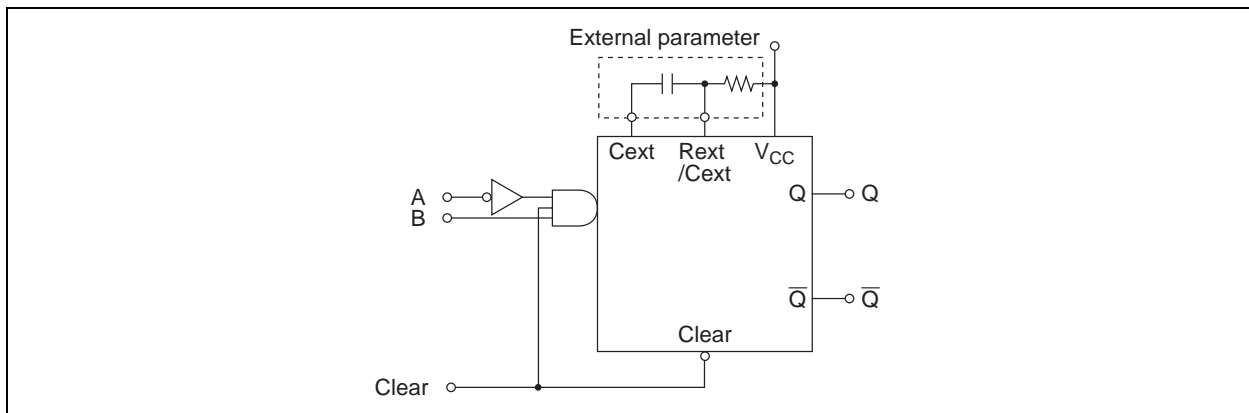


Function Table

Inputs			Outputs	
Clear	A ₁	B ₂	Q	Q̄
L	X	X	L	H
X	H	X	L	H
X	X	L	L	H
H	L	↑	⌋	⌋
H	↓	H	⌋	⌋
↑	L	H	⌋	⌋

Notes: H; high level, L; low level, X; irrelevant
 ↑; transition from low to high level
 ↓; transition from high to low level
 ⌋; one high-level pulse
 ⌋; one low-level pulse

Block Diagram (1/2)



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage	V_{CC}	7	V
Input voltage	V_{IN}	7	V
Power dissipation	P_T	400	mW
Storage temperature	T_{stg}	-65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

Recommended Operating Conditions

Item	Symbol	Min	Typ	Max	Unit
Supply voltage	V_{CC}	4.75	5.00	5.25	V
Output current	I_{OH}	—	—	-400	μA
	I_{OL}	—	—	8	mA
Operating temperature	T_{opr}	-20	25	75	°C
Input pulse width	A, B	"H"	t_w (in)	40	ns
		"L"		40	ns
	CLR	"L"		40	ns
External timing resistance	R_{ext}	5	—	260	k Ω
External capacitance	C_{ext}	Non restriction			
Wiring capacitance at R_{ext}/C_{ext} terminal		—	—	50	pF

Electrical Characteristics

($T_a = -20$ to $+75$ °C)

Item	Symbol	min.	typ.*	max.	Unit	Condition
Input voltage	V_{IH}	2.0	—	—	V	
	V_{IL}	—	—	0.8	V	
Output voltage	V_{OH}	2.7	—	—	V	$V_{CC} = 4.75$ V, $V_{IH} = 2$ V, $V_{IL} = 0.8$ V, $I_{OH} = -400$ μA
	V_{OL}	—	—	0.4	V	$V_{CC} = 4.75$ V, $V_{IH} = 2$ V, $V_{IL} = 0.8$ V
—		—	0.5			
Input current	I_{IH}	—	—	20	μA	$V_{CC} = 5.25$ V, $V_I = 2.7$ V
	I_{IL}	—	—	-0.4	mA	$V_{CC} = 5.25$ V, $V_I = 0.4$ V
	I_I	—	—	0.1	mA	$V_{CC} = 5.25$ V, $V_I = 7$ V
Short-circuit output current	I_{OS}	-20	—	-100	mA	$V_{CC} = 5.25$ V
Supply current**	I_{CC}	—	12	20	mA	$V_{CC} = 5.25$ V
Input clamp voltage	V_{IK}	—	—	-1.5	V	$V_{CC} = 4.75$ V, $I_{IN} = -18$ mA

* $V_{CC} = 5$ V, $T_a = 25$ °C

** With all outputs open and 4.5 V applied to all data and clear inputs, I_{CC} is measured after a momentary ground, then 4.5 V, is applied to clock.

Note: To measure V_{OH} at Q, V_{OL} at \bar{Q} , or I_{OS} at Q, ground R_{ext} / C_{ext} , apply 2 V to B and clear, and pulse A from 2 V to 0 V.

Switching Characteristics

($V_{CC} = 5\text{ V}$, $T_a = 25^\circ\text{C}$)

Item	Symbol	Inputs	Outputs	min.	typ.	max.	Unit	Condition
Propagation delay time	t_{PLH}	A	Q	—	23	33	ns	$C_{ext} = 0$, $R_{ext} = 5\text{ k}\Omega$, $C_L = 15\text{ pF}$, $R_L = 2\text{ k}\Omega$
	t_{PHL}		\bar{Q}	—	32	45		
	t_{PLH}	B	Q	—	23	44		
	t_{PHL}		\bar{Q}	—	34	56		
	t_{PLH}	CLR	Q	—	20	27		
	t_{PHL}		\bar{Q}	—	28	45		
Output pulse width	$t_{(out)min}$	A, B	Q	—	116	200	μs	$C_{ext} = 1000\text{ pF}$, $R_{ext} = 10\text{ k}\Omega$, $C_L = 15\text{ pF}$, $R_L = 2\text{ k}\Omega$
	$t_{(out)}$		Q	4	4.5	5		

Typical Application Data for HD74LS123

For pulse widths when $C_{ext} \leq 1000\text{ pF}$, See Figure 3.

The output pulse is primarily a function of the external capacitor and resistor. For $C_{ext} > 1000\text{ pF}$, the output pulse width (t_w) is defined as: $t_{w(out)} = K \cdot R_{ext} \cdot C_{ext}$; See Figure 4.

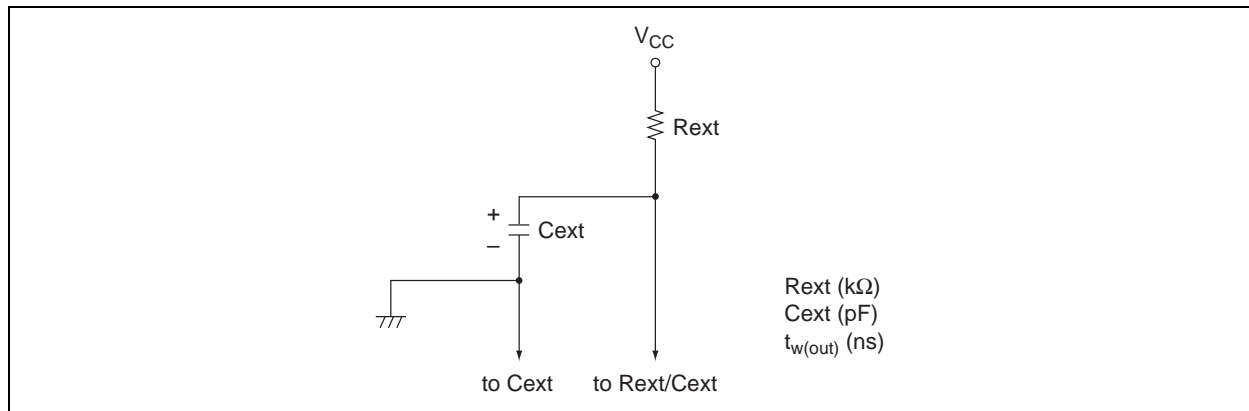


Figure 2 Timing Component Connections

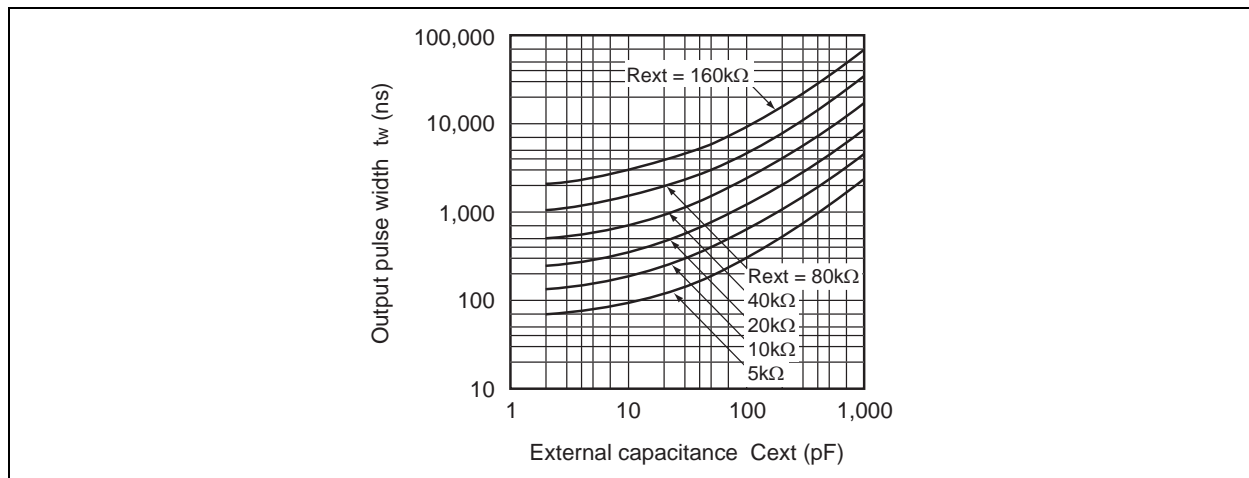


Figure 3 Typical Output Pulse Width ($C_{ext} \leq 1000\text{ pF}$)

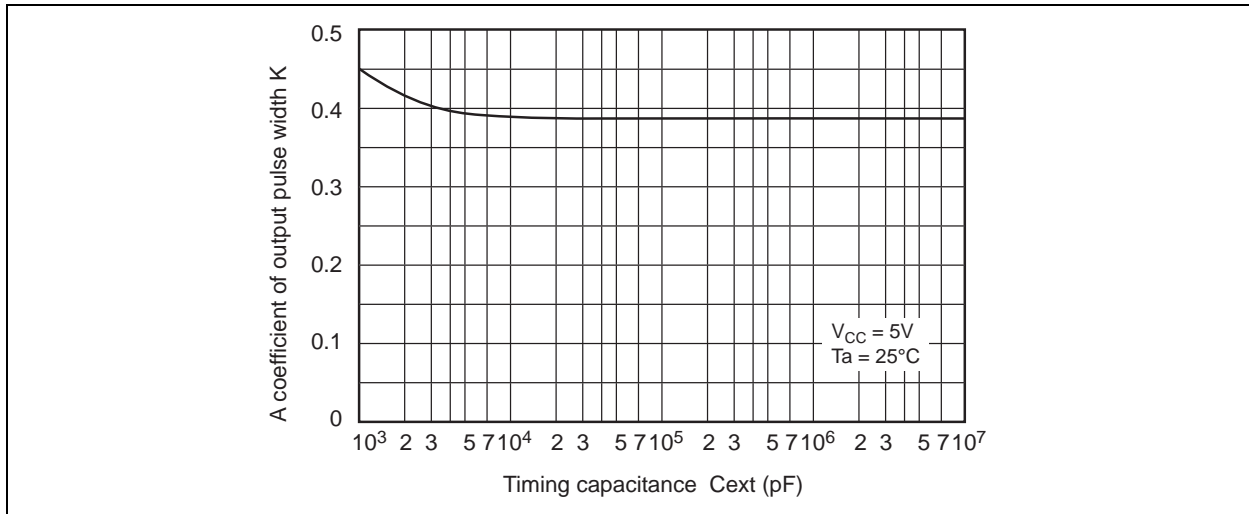
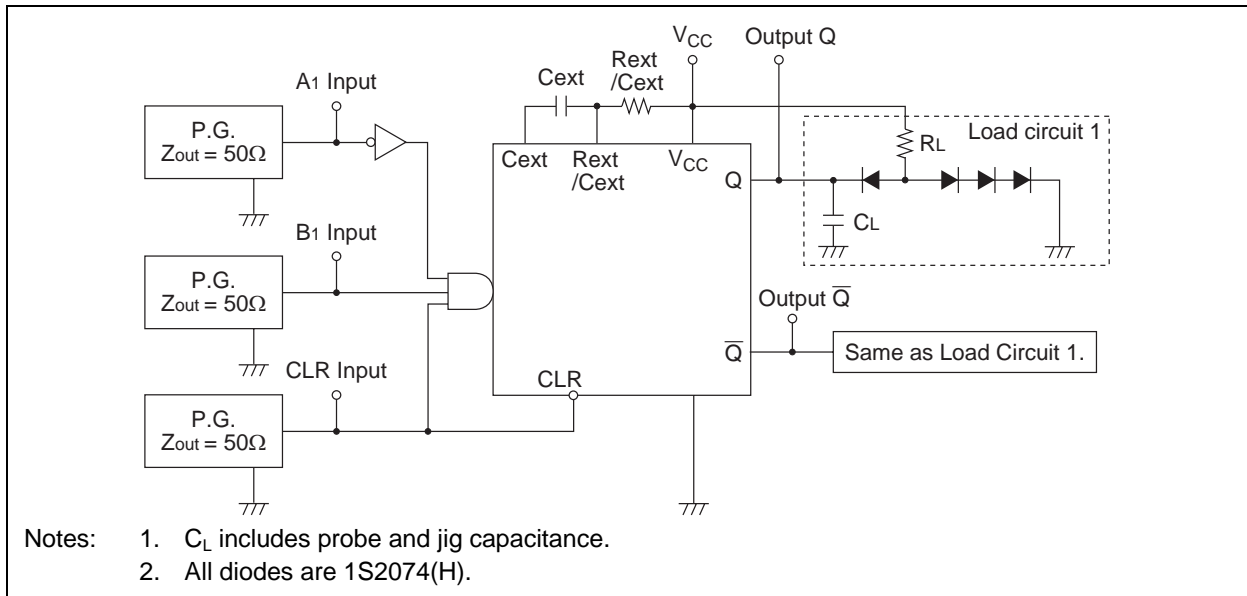


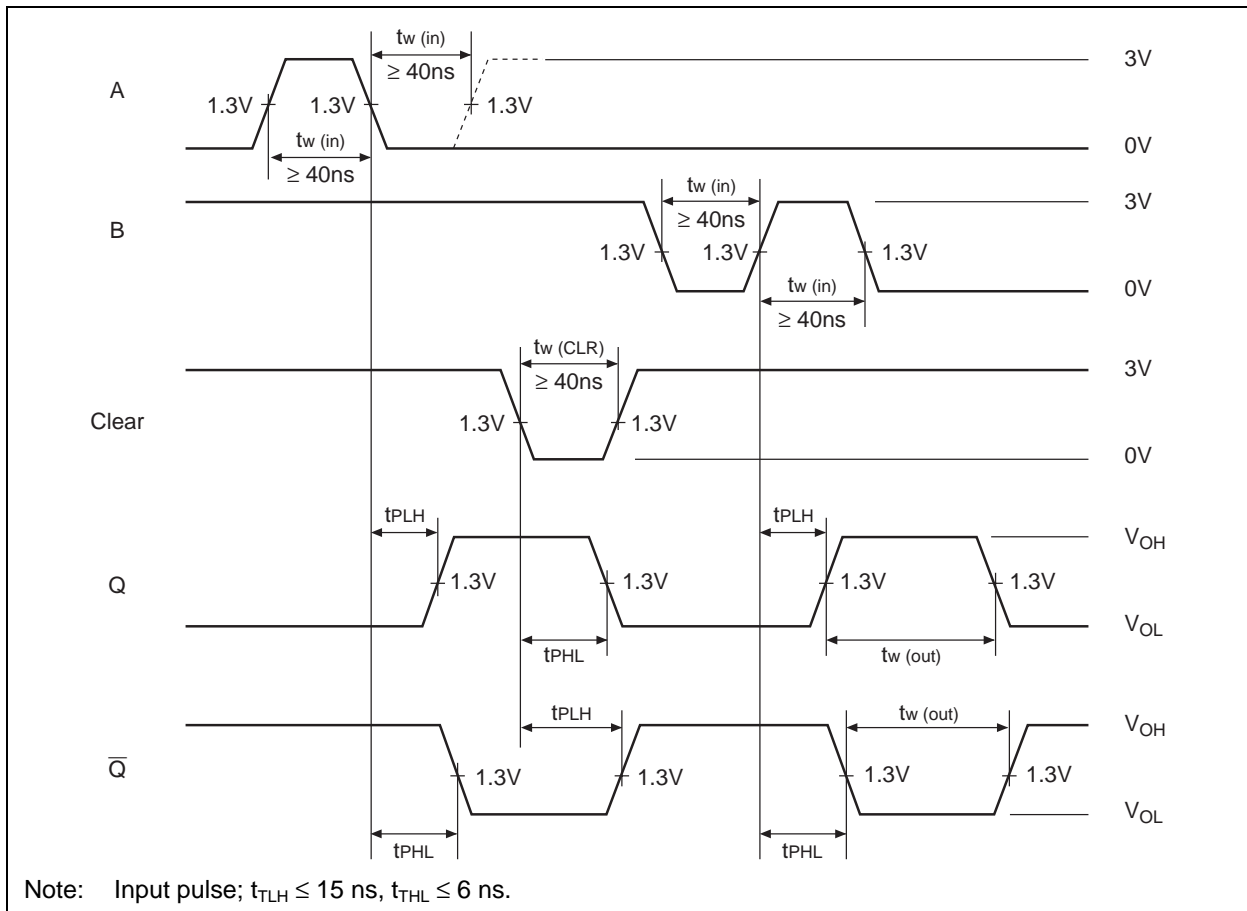
Figure 4 C_{ext} vs. K ($C_{ext} > 1000$ pF)

Testing Method

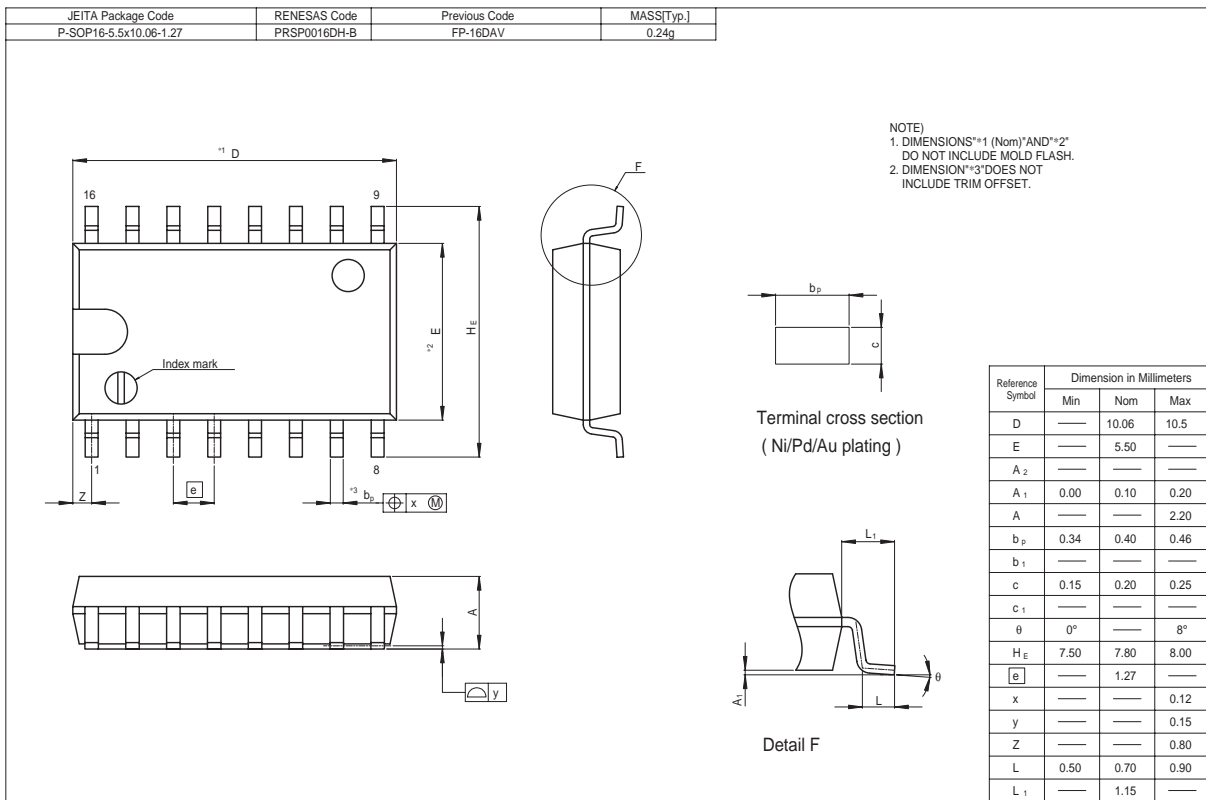
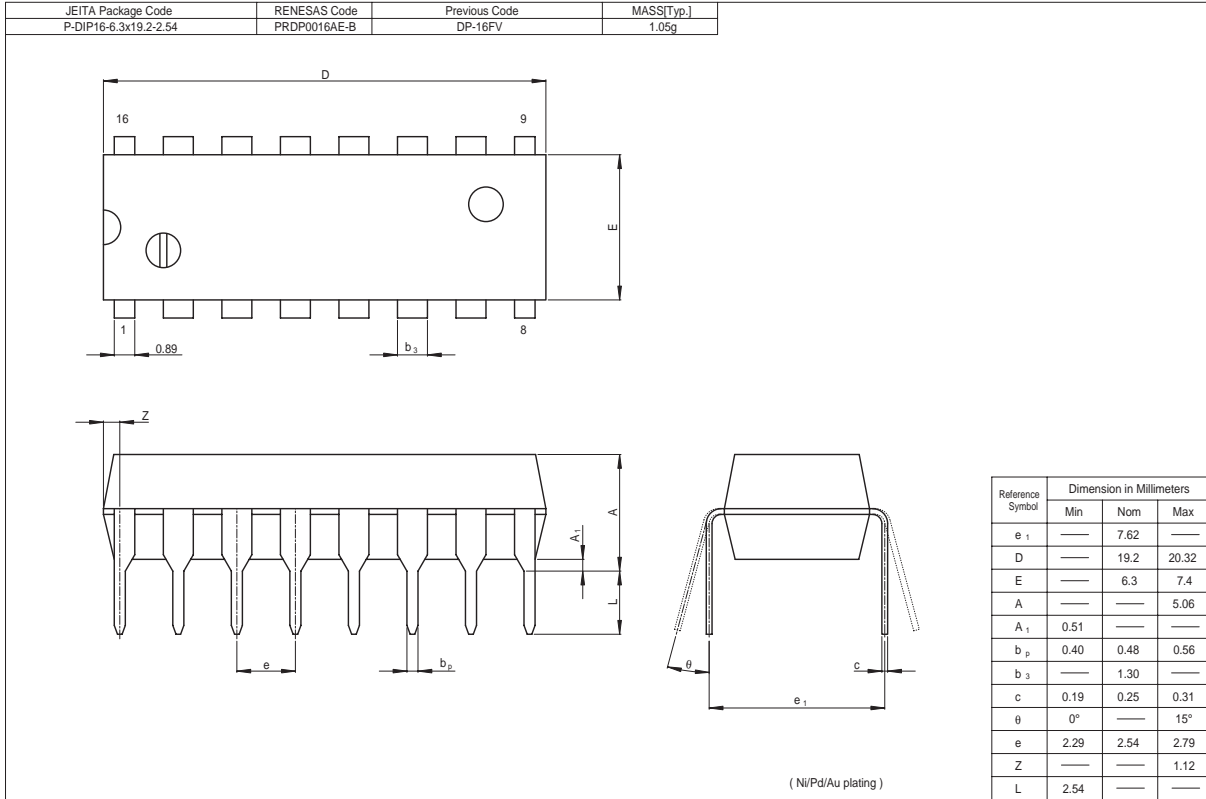
Test Circuit



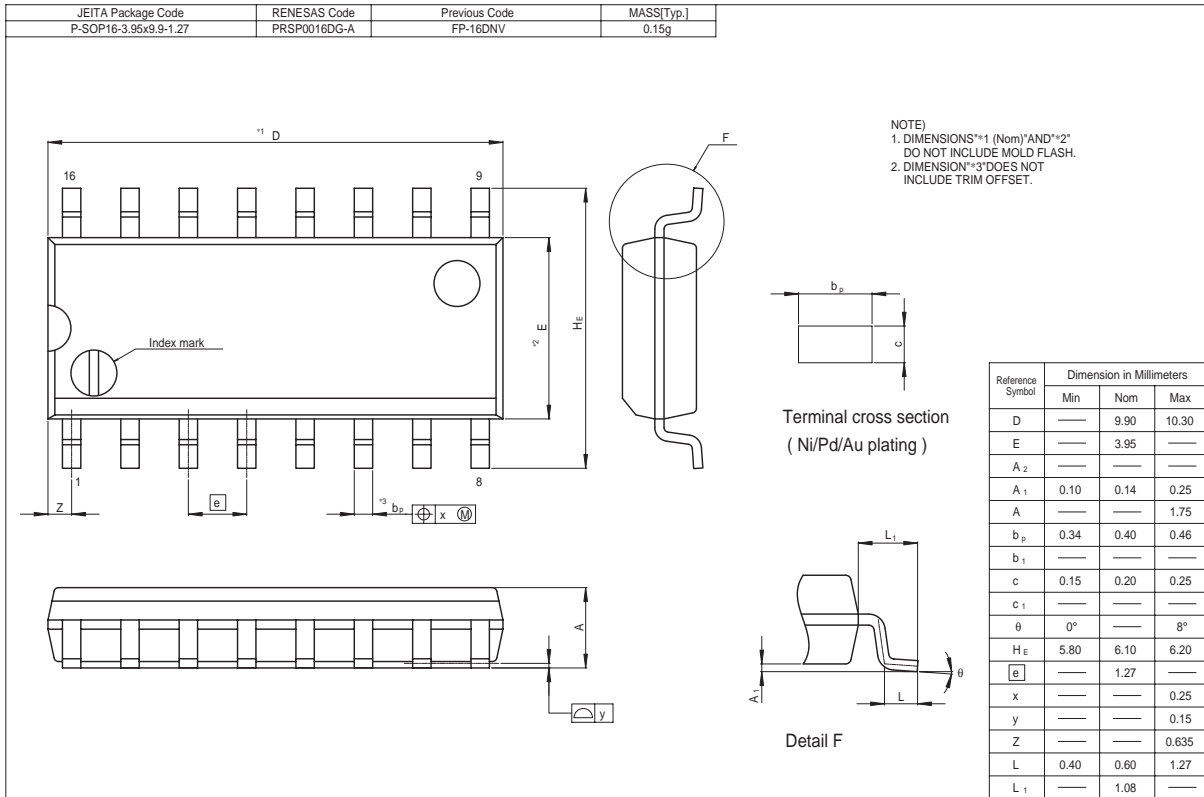
Waveform



Package Dimensions



HD74LS123



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